

### ● General Description

The AGM401LL combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

This device is ideal for load switch and battery protection applications.

### ● Features

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

### ● Application

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM401LL	AGM401LL	TOLL	----	----	2000

**Table 1. Absolute Maximum Ratings (TA=25°C)**

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	40	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25°C) <b>(Note 1)</b>	200	A
	Drain Current-Continuous(Tc=100°C)	137	A
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed <b>(Note 2)</b>	730	A
PD	Maximum Power Dissipation(Tc=25°C)	250	w
	Maximum Power Dissipation(Tc=100°C)	100	w
EAS	Avalanche energy <b>(Note 3)</b>	752	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C

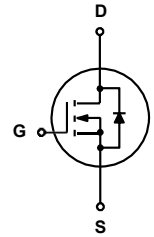
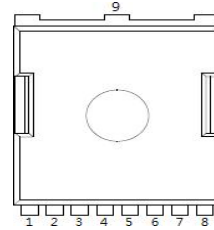
**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) <sup>1</sup>	---	40	°C/W
RθJC	Thermal Resistance Junction-Case <sup>1</sup>	---	0.5	°C/W

### Product Summary

BVDSS	RDS(ON)	ID
40V	1.5mΩ	200A

### TOLL Pin Configuration



Pin	Description
1	Gate(G)
2,3,4,5,6,7,8	Source(S)
9	Drain(D)

**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

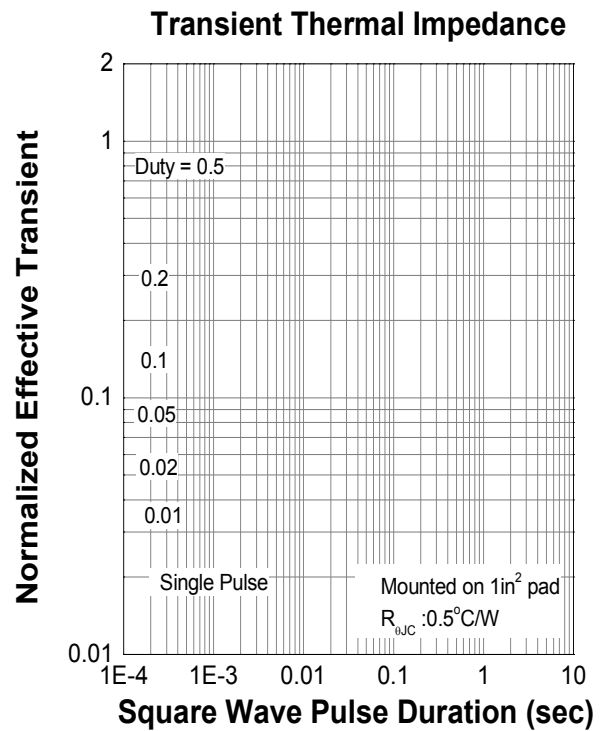
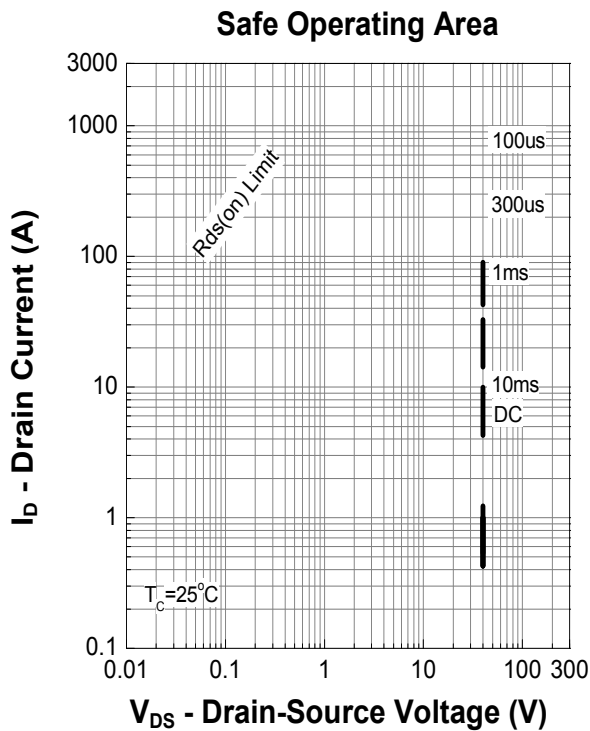
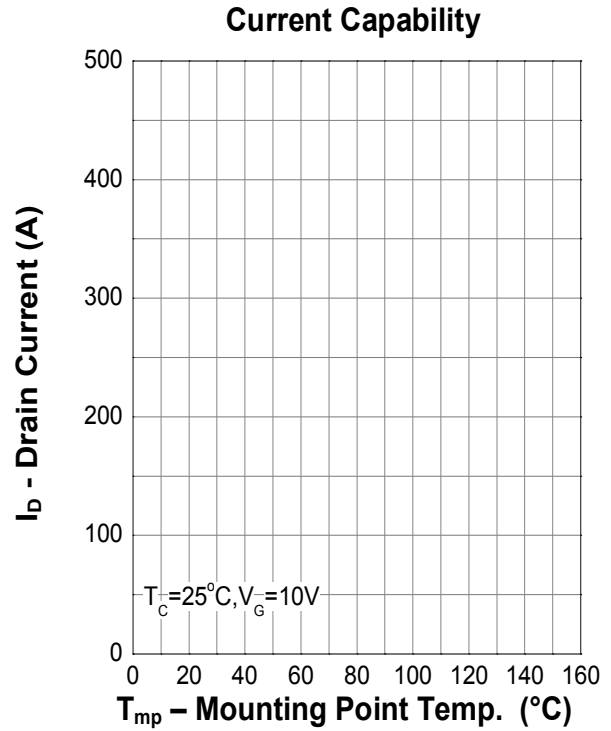
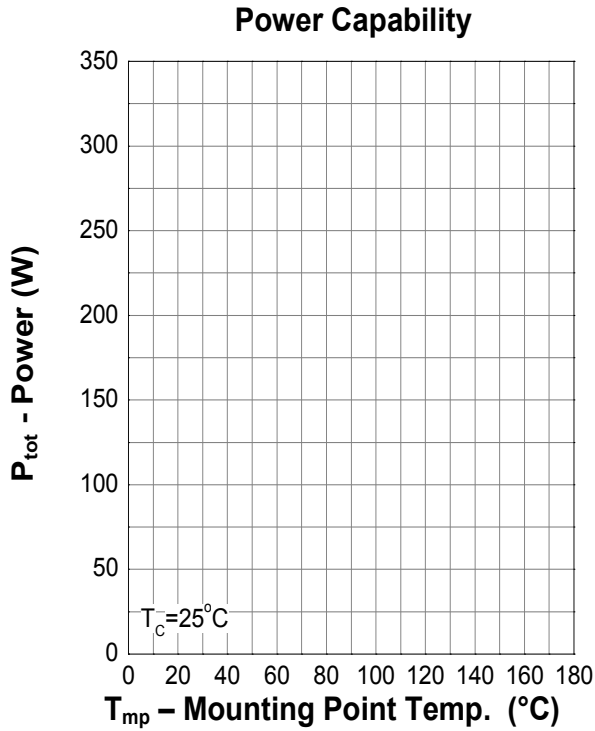
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	40	45	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=40V,VGS=0V	--	--	1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	1.3	1.7	2.5	V
gFS	Forward Transconductance	VDS=5V,ID=20A	--	--	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=40A	--	1.5	2.0	mΩ
		VGS=4.5V, ID=20A	--	2.5	5.0	mΩ
<b>Dynamic Characteristics</b>						
Ciss	Input Capacitance	VDS=20V,VGS=0V, F=1MHZ	--	4740	--	pF
Coss	Output Capacitance		--	1515	--	pF
Crss	Reverse Transfer Capacitance		--	122	--	pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz	--	1.2	--	Ω
<b>Switching Times</b>						
td(on)	Turn-on Delay Time	VGS=10V,VDS=20V, ID=40A,RGEN=3Ω	--	15.7	--	nS
tr	Turn-on Rise Time		--	47	--	nS
td(off)	Turn-Off Delay Time		--	72	--	nS
tf	Turn-Off Fall Time		--	40	--	nS
Qg	Total Gate Charge	VGS=10V, VDS=20V, ID=40A	--	81	--	nC
Qgs	Gate-Source Charge		--	18	--	nC
Qgd	Gate-Drain Charge		--	15	--	nC
<b>Source-Drain Diode Characteristics</b>						
ISD	Source-Drain Current(Body Diode)		--	--	200	A
VSD	Forward on Voltage	VGS=0V,IS=40A	--	0.8	1.3	V
trr	Reverse Recovery Time	IF=40A , dI/dt=100A/μs , TJ=25°C	--	--	--	ns
Qrr	Reverse Recovery Charge		--	--	--	nc

Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

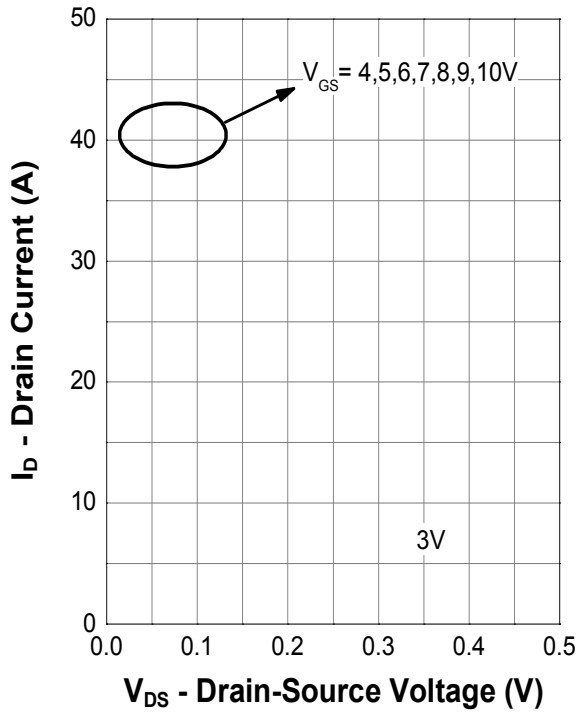
Notes 3.EAS condition: TJ=25°C

## Typical Characteristics

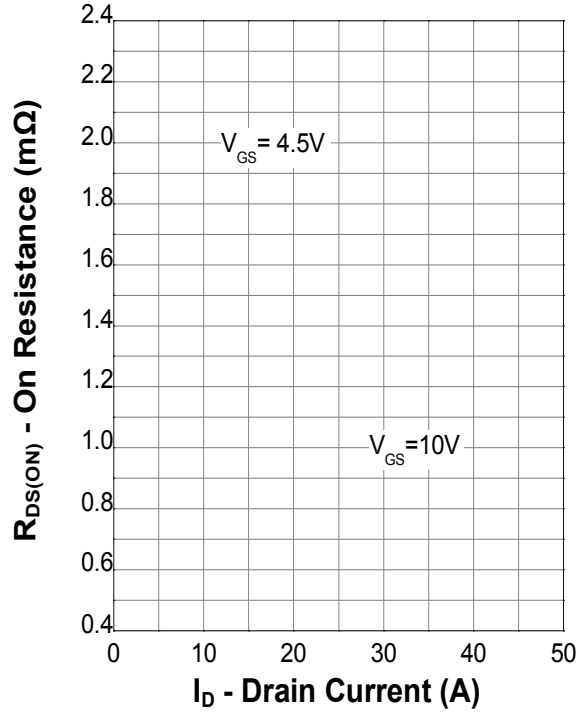


## . Typical Characteristics (Cont.)

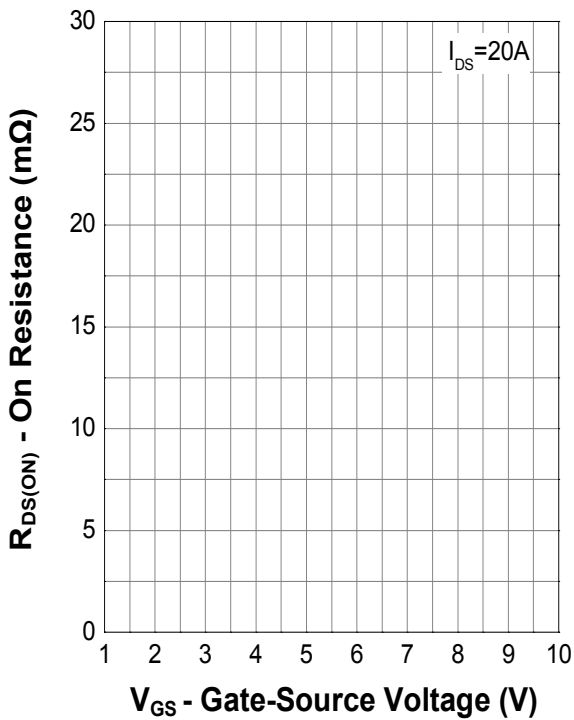
### Output Characteristics



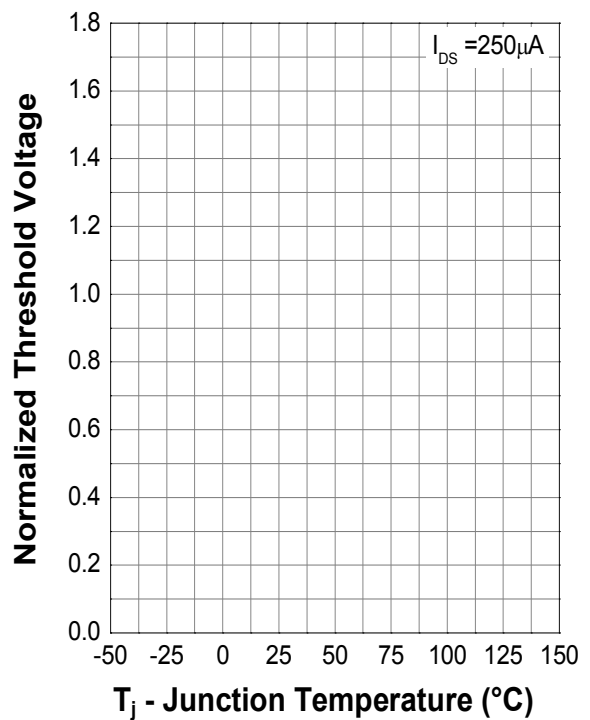
### On Resistance



### Transfer Characteristics

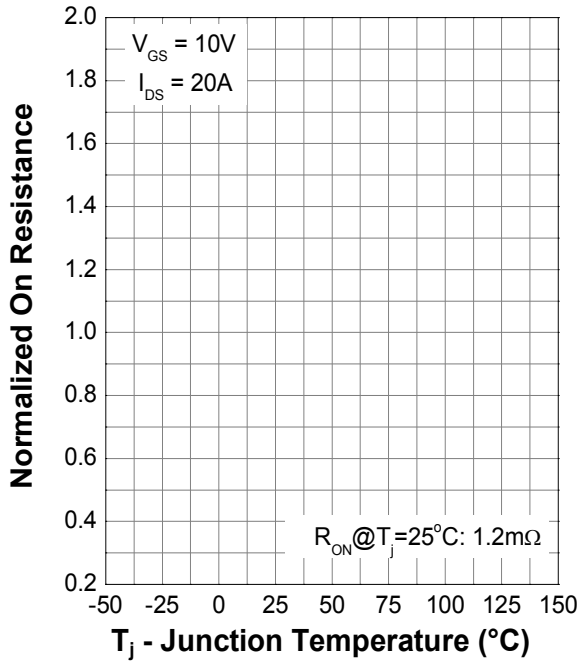


### Normalized Threshold Voltage

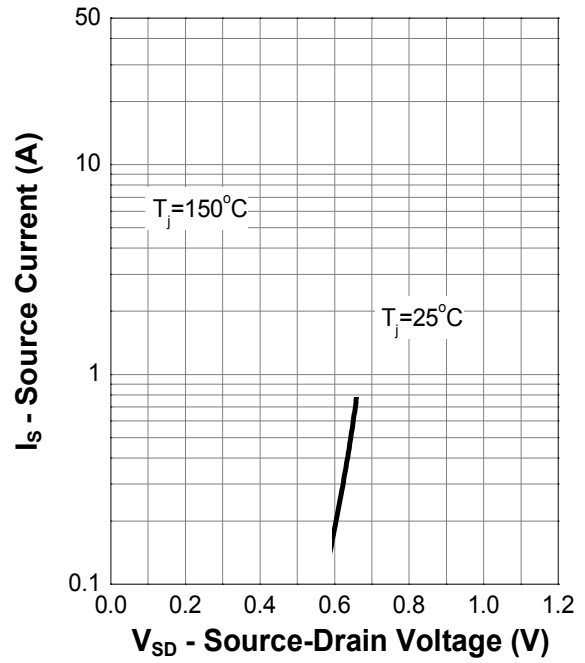


## . Typical Characteristics (Cont.)

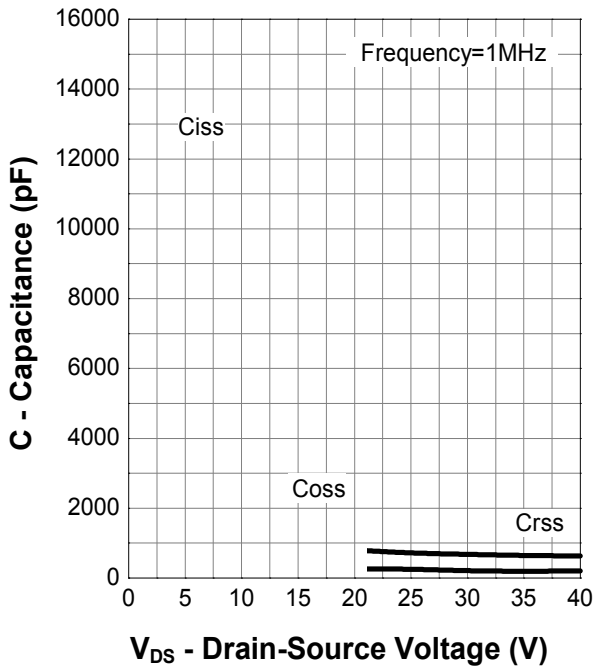
### Normalized On Resistance



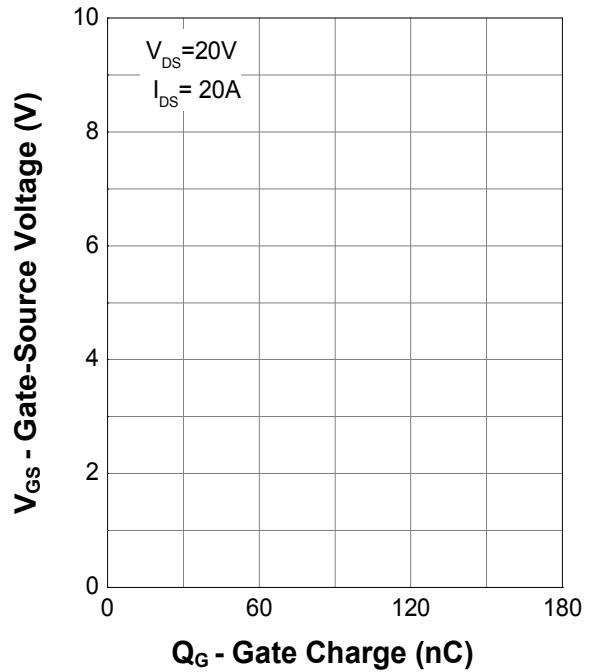
### Diode Forward Current



### Capacitance

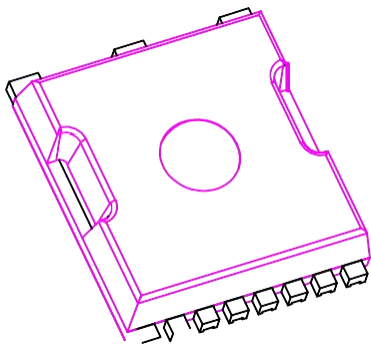
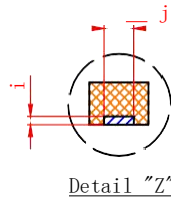
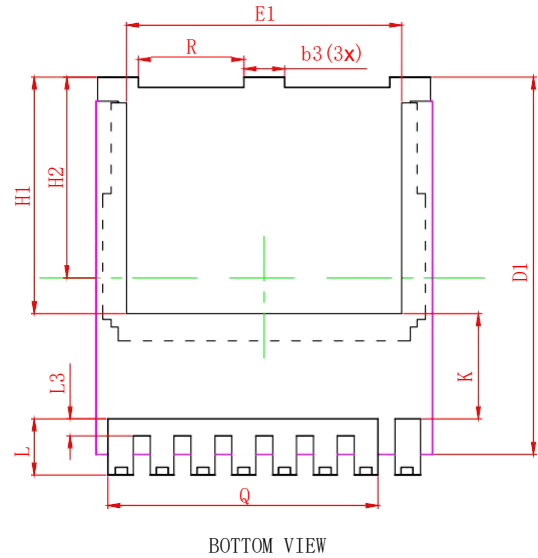
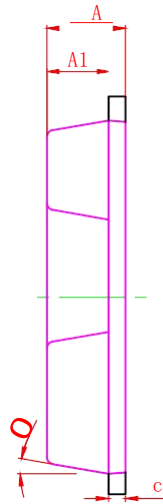
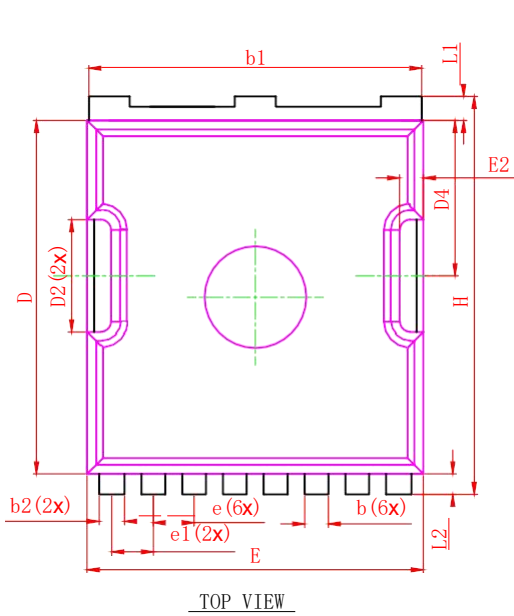


### Gate Charge



# Package Dimensions

## TOLL-8L Package



SYMBOL	MILLIMETER		
	MIN.	NOM.	MAX.
A	2.200	2.300	2.400
A1	1.700	1.800	1.900
b	0.600	0.700	0.800
b1	9.700	9.800	9.900
b2	0.650	0.750	0.850
b3	1.100	1.200	1.300
c	0.400	0.500	0.600
D	10.300	10.400	10.500
D1	11.000	11.100	11.200
D2	3.200	3.300	3.400
D4	4.470	4.570	4.670
E	9.800	9.900	10.000
E1	8.000	8.100	8.200
E2	0.500	0.600	0.700
e	1.200 BSC		
e1	1.225 BSC		
H	11.600	11.700	11.800
H1	6.950 BSC		
H2	5.900 BSC		
i	0.100 REF.		
j	0.350 REF.		
K	3.100 REF.		
L	1.550	1.650	1.750
L1	0.600	0.700	0.800
L2	0.500	0.600	0.700
L3	0.400	0.500	0.600
Q	7.950 REF.		
R	3.000	3.100	3.200
Ø	10°REE.		


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